

PRELIMINARY DATA SHEET

SKY73025: 2300 – 2700 MHz High Gain and Linearity Diversity Downconversion Mixer

Applications

- 2G/3G base station transceivers:
 - GSM/EDGE, CDMA, UMTS/WCDMA
- WiFi (802.11)
- WiMAX (802.16)
- 3GPP long-term evolution
- Land mobile radio
- Wireless Local Loop
- High performance radio links
- Private mobile radio

Features

- Operating frequency range: 2300 to 2700 MHz
- IF frequency range: 50 to 500 MHz
- Conversion gain: 8.6 dB
- Input IP3: +23.5 dBm
- Output IP3: +32.1 dBm
- Noise Figure: 9.8 dB
- Integrated LO drivers
- Integrated low loss RF baluns
- High linearity IF amplifiers
- On-chip SPDT LO switch (greater than 45 dB LO-to-LO isolation)
- Small, MCM (36-pin, 6 x 6 mm) Pb-free package (MSL3, 260 °C per JEDEC J-STD-020)



Skyworks offers lead (Pb)-free RoHS (Restriction of Hazardous Substances) compliant packaging.

Description

The SKY73025 is a fully integrated diversity mixer that includes Local Oscillator (LO) drivers, an LO switch, high linearity mixers, and large dynamic range Intermediate Frequency (IF) amplifiers. Low loss RF baluns have also been included to reduce design complications and lower system cost.

The SKY73025 features an input IP3 of +23.5 dBm and a Noise Figure (NF) of 9.8 dB, making the device an ideal solution for high dynamic range systems such as 2G/3G base station receivers. The LO switch provides more than 45 dB of isolation between LO inputs and supports the switching time required for GSM/EDGE base stations.

The SKY73025 is manufactured using a robust silicon BiCMOS process and has been designed for optimum long-term reliability. The SKY73025 diversity downconversion mixer is provided in a compact, 36-pin 6 x 6 mm Multi-Chip Module (MCM). A functional block diagram is shown in Figure 1. The pin configuration and package are shown in Figure 2. Signal pin assignments and functional pin descriptions are provided in Table 1.

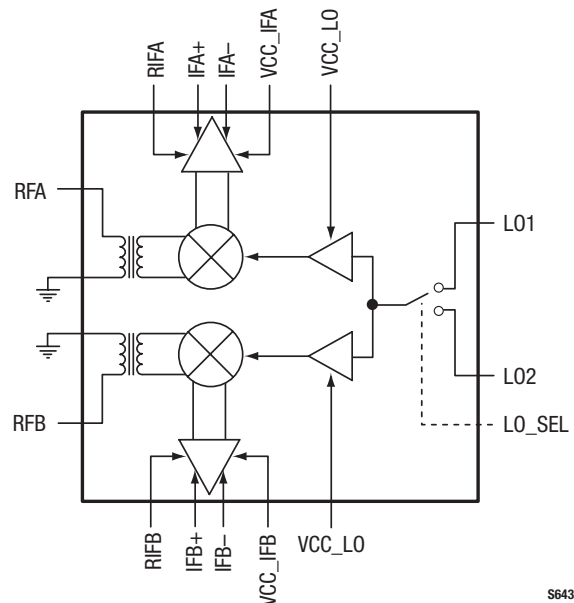


Figure 1. SKY73025 Block Diagram

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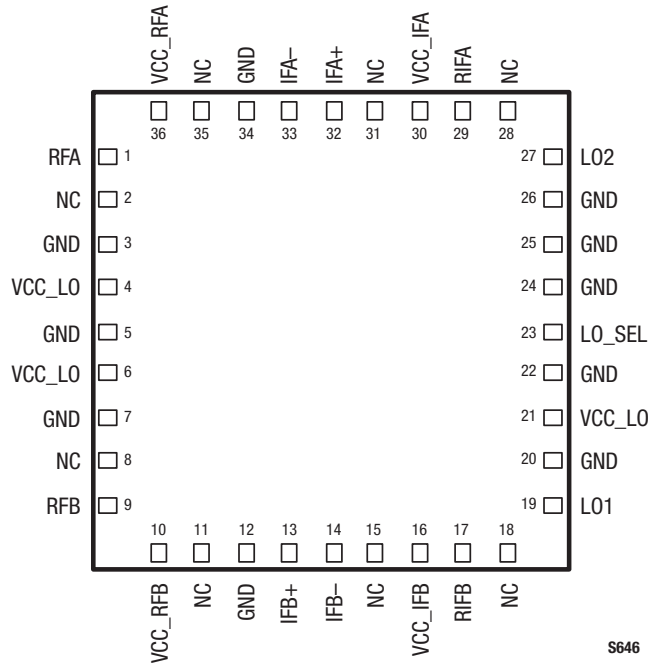


Figure 2. SKY73025 Pinout – 36-Pin MCM

Table 1. SKY73025 Signal Descriptions

Pin #	Name	Description	Pin #	Name	Description
1	RFA	Channel A RF input	19	LO1	Local oscillator 1 input
2	NC	No connect	20	GND	Ground
3	GND	Ground	21	VCC_LO	DC supply, +5 V
4	VCC_LO	DC supply, +5 V	22	GND	Ground
5	GND	Ground	23	LO_SEL	Local oscillator select switch control
6	VCC_LO	DC supply, +5 V	24	GND	Ground
7	GND	Ground	25	GND	Ground
8	NC	No connect	26	GND	Ground
9	RFB	Channel B RF input	27	LO2	Local oscillator 2 input
10	VCC_RFB	Channel B RF DC supply, +5 V	28	NC	No connect
11	NC	No connect	29	RIFA	Channel A IF bias adjust
12	GND	Ground	30	VCC_IFA	Channel A IF DC supply, +5 V
13	IFB+	Positive channel B IF output	31	NC	No connect
14	IFB-	Negative channel B IF output	32	IFA+	Positive channel A IF output
15	NC	No connect	33	IFA-	Negative channel A IF output
16	VCC_IFB	Channel B IF DC supply, +5 V	34	GND	Ground
17	RIFB	Channel B IF bias adjust	35	NC	No connect
18	NC	No connect	36	VCC_RFA	Channel A RF DC supply, +5 V

Functional Description

The SKY73025 is a high gain diversity mixer, optimized for base station receiver applications. The device consists of two diversity channels (A and B), each consisting of a low loss RF balun, high linearity passive mixer, and a low noise IF amplifier.

Two LO amplifiers (independent of channels A and B) are also included that allow the SKY73025 to connect directly to the output of a Voltage Controlled Oscillator (VCO). This eliminates the extra gain stages needed by most discrete passive mixers. A Single Pole, Double Throw (SPDT) switch has been included to select between two different LO inputs for frequency hopping applications (i.e., GSM).

RF Baluns and Passive Mixer

The RF baluns provide a single ended input, which can easily be matched to $50\ \Omega$ using a simple external matching circuit. The RF baluns offer very low loss, and excellent amplitude and phase balance.

The high linearity SKY73025 is a passive, double balanced mixer that provides a very low conversion loss and an excellent 3rd Order Input Intercept Point (IIP3).

Additionally, the balanced nature of the mixer provides for high port-to-port isolation.

LO Buffers and SPDT LO Switch

The LO buffers allow the input power of the SKY73025 to be in the range of ± 6 dBm. The LO section is optimized for low-side LO injection. However, each of the two LOs can be driven over a wide frequency range with only slight degradation in performance.

A high isolation SPDT switch allows the SKY73025 to be used for frequency hopping applications. This switch provides greater than 45 dB of LO1 to LO2 isolation:

LO_SEL Input	LO Path Selected
High	LO1 (pin 19) enabled
Low	LO2 (pin 27) enabled

For applications that do not require frequency hopping, LO_SEL is fixed to one state and the appropriate LO input is used. An internal pull-down resistor enables the LO2 input.

IF Amplifier

The SKY73025 includes high dynamic range IF amplifiers that follow the passive mixers in the signal path. The outputs require a supply voltage connection using inductive chokes. These choke inductors should be high-Q and have the ability to handle 200 mA or greater.

A simple matching network allows the output ports to be matched to a balanced $200\ \Omega$ impedance. The IF amplifiers are optimized for IF frequencies between 50 and 500 MHz. The IF amplifiers can be operated outside of this range, but with a slight degradation in performance.

The RIFA and RIFB pins (29 and 17, respectively) can be connected to external resistors (R1 and R2 – see Figure 3) to reduce the IF amplifier bias current. When a resistor is connected to pin 29 (R2), the Channel A IF amplifier current is reduced. When a resistor is connected to pin 17 (R1), the Channel B IF amplifier current is reduced. The total amount of current reduced for Channel A and B IF amplifiers is the amount of mixer current that is reduced.

Table 2 shows the change in Channel A and/or B amplifier current from using either of three different external resistors.

For example, if a $10\ \text{k}\Omega$ resistor is used on pin 29 and a $5.1\ \text{k}\Omega$ resistor is used on pin 17, the Channel A IF amplifier current is reduced by 7 mA and the Channel B IF amplifier current is reduced by 14 mA. The total mixer current is reduced by 21 mA (7 mA + 14 mA).

Note that the use of any external resistors on either of these two pins also degrades IIP3 performance. Skyworks recommends using external resistors no smaller than $1\ \text{k}\Omega$.

Electrical and Mechanical Specifications

The absolute maximum ratings of the SKY73025 are provided in Table 3 and the recommended operating conditions in Table 4. Electrical characteristics for the SKY73025 are provided in Table 5.

Table 2. IF Amplifier Bias Current Adjustment

External Resistor Connected to Pin 17 and/or Pin 29 (kΩ)	Channel A and/or Channel B IF Amplifier Bias Current Change (mA)
No external resistor	0
10	-7
5.1	-14
2.2	-33

Note: The resistor values listed here were those tested. Other resistor values can be used with similar reductions in bias current.

Table 3. SKY73025 Absolute Maximum Ratings

Parameter	Symbol	Minimum	Maximum	Units
Supply voltage, +5 V	VCC	4.5	5.5	V
Supply current	I _{CC}		440	mA
RF input power	P _{RF}		+20	dBm
LO input power	P _{LO}		+20	dBm
Operating case temperature	T _C	-40	+85	°C
Junction temperature	T _J		+150	°C
Storage case temperature	T _{STG}	-40	+125	°C

Notes: Exposure to maximum rating conditions for extended periods may reduce device reliability. There is no damage to device with only one parameter set at the limit and all other parameters set at or below their nominal value.

Nominal thermal resistance (junction to center ground pad) is 5.1 °C/W.

Table 4. SKY73025 Recommended Operating Conditions

Parameter	Symbol	Minimum	Typical	Maximum	Units
Supply voltage, +5 V (VCC1 – VCC7)	VCC	4.75	5.00	5.25	V
Supply current	I _{CC}		375		mA
LO input power	P _{LO}	-6	0	+6	dBm
LO select input: high low	LO_SELH LO_SELL	2.2		0.8	V V
Operating case temperature	T _C	-40		+85	°C
RF frequency range	F _{RF}	2300		2700	MHz
LO frequency range (Note 1)	F _{LO}	1800		2600	MHz
IF frequency range	F _{IF}	50		500	MHz

Note 1: The SKY73025 has been optimized for low-side LO injection. However, the LO can be used outside of the specified frequency range with degraded performance.

Table 5. SKY73025 Electrical Specifications**(Voltage Supply = +5 V, T_c = +25 °C, LO = 0 dBm, RF Frequency = 2570 MHz, IF Frequency = 450 MHz, LO Frequency = 2120 MHz, Unless Otherwise Noted)**

Parameter	Symbol	Test Condition	Min	Typical	Max	Units
Conversion gain	G			8.6		dB
Noise Figure	NF			9.8		dB
Noise Figure with a blocker signal	NF _{BLK}	Blocking signal input power = +8 dBm			25	dB
Third order input intercept point	IIP3	F _{RF} = 2570 MHz and 2570.8 MHz, P _{RF} = -10 dBm/tone		+23.5		dBm
Third order output intercept point	OIP3	F _{RF} = 2570 MHz and 2570.8 MHz, P _{RF} = -10 dBm/tone		+32.1		dBm
2RF – 2LO	2x2	P _{RF} = -10 dBm		-62		dBc
3RF – 3LO	3x3	P _{RF} = -10 dBm		-73		dBc
Input 1 dB compression point	IP1dB			+12.3		dBm
Output 1 dB compression point	OP1dB			+19.9		dBm
LO1-to-LO2 isolation				45		dB
Channel-to-channel isolation				25		dB
RF-to-IF-isolation				30		dB
LO leakage: @ RF port @ IF port				-30 -20		dBm dBm
LO_SEL input			-20	150	250	μA
LO switching time					0.5	μs
RF port input return loss	Z _{IN_RF}	With external matching components	14			dB
LO port input return loss	Z _{IN_LO}	With external matching components	14			dB
IF port input return loss	Z _{OUT_IF}	With external matching components	14			dB

Application Circuit Design Considerations

RF Input and IF Output Matching

For best performance, RF and IF matching circuits are needed either for a differential output application or for a single-ended output application. A typical single-ended output application circuit is shown in Figure 3.

The 200 Ω differential IF output impedance could be used to connect to a differential input Surface Acoustic Wave (SAW) filter or Variable Gain Amplifier (VGA). A 4:1 balun transformer could also be used to match the impedance to 50 Ω for a single-ended output application.

As noted in Figure 3, components C1, C2, L1, L2, L3, and L4 are RF matching components; C8, C10, L9, and L10 are IF matching components; T1 and T2 are 4:1 IF baluns.

IF Bias Resistor

Components R1 and R2 (see Figure 3) are for the IF amplifier bias current adjustment. To operate the SKY73025 as specified in Tables 4 and 5, these resistors are not required.

PCB Layout

The following design considerations are general in nature and must be followed regardless of final use or configuration.

1. Paths to ground should be made as short and as low impedance as possible.

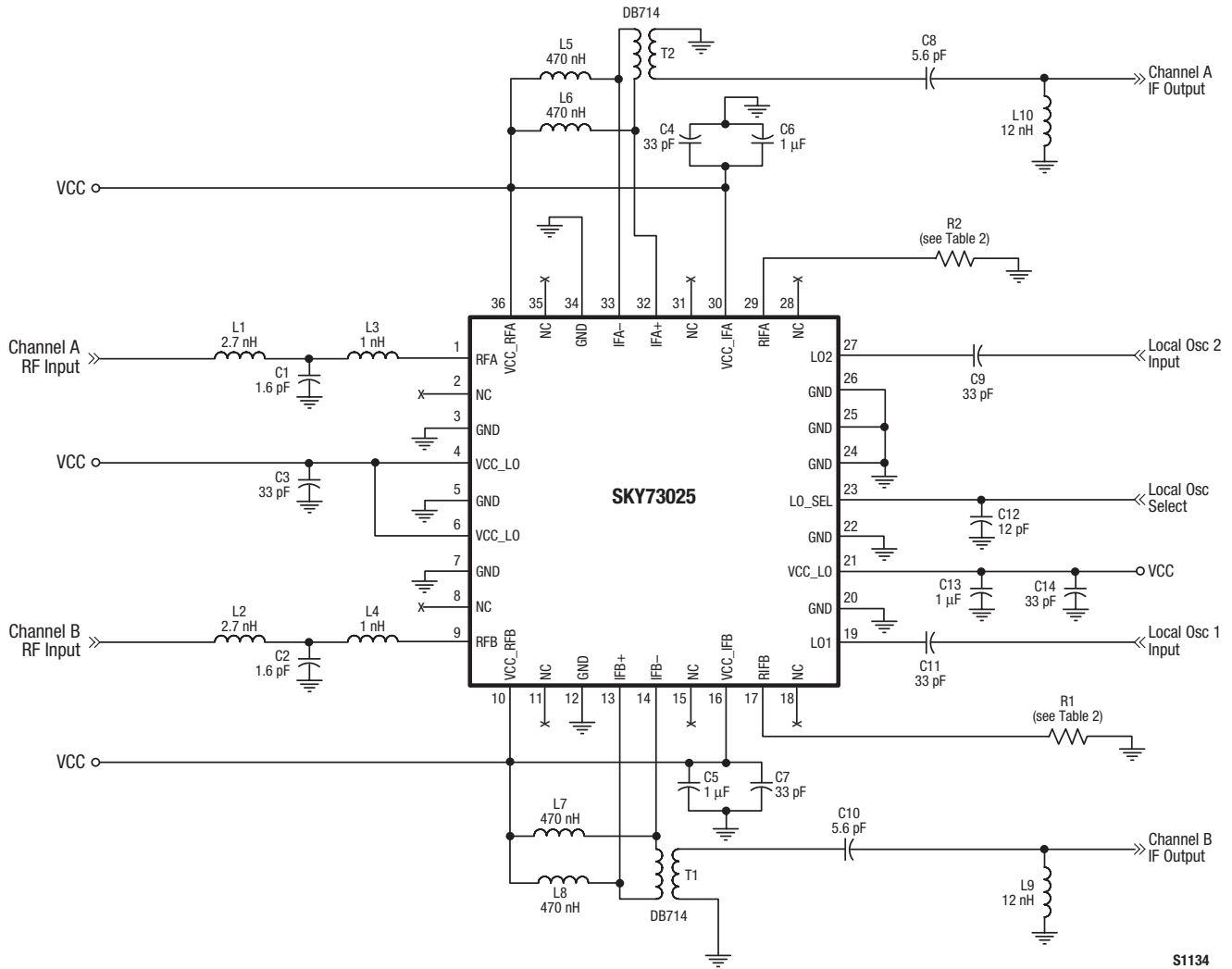
2. The ground pad of the SKY73025 provides critical electrical and thermal functionality. This pad is the main thermal conduit for heat dissipation. Since the circuit board acts as the heat sink, it must shunt as much heat as possible from the device. Therefore, design the connection to the ground pad to dissipate the maximum heat produced by the circuit board. For more information on soldering the SKY73025, refer to the Package and Handling Information section of this Data Sheet.

DC Power Supply

1. Skyworks recommends including external bypass capacitors on the VCC voltage inputs of the device. Place the bypass capacitors close to the VCC supply pins.
2. Components L5, L6, L7, and L8 (see Figure 3) are high-Q, low loss inductors. These inductors must be able to pass currents in excess of 200 mA DC.

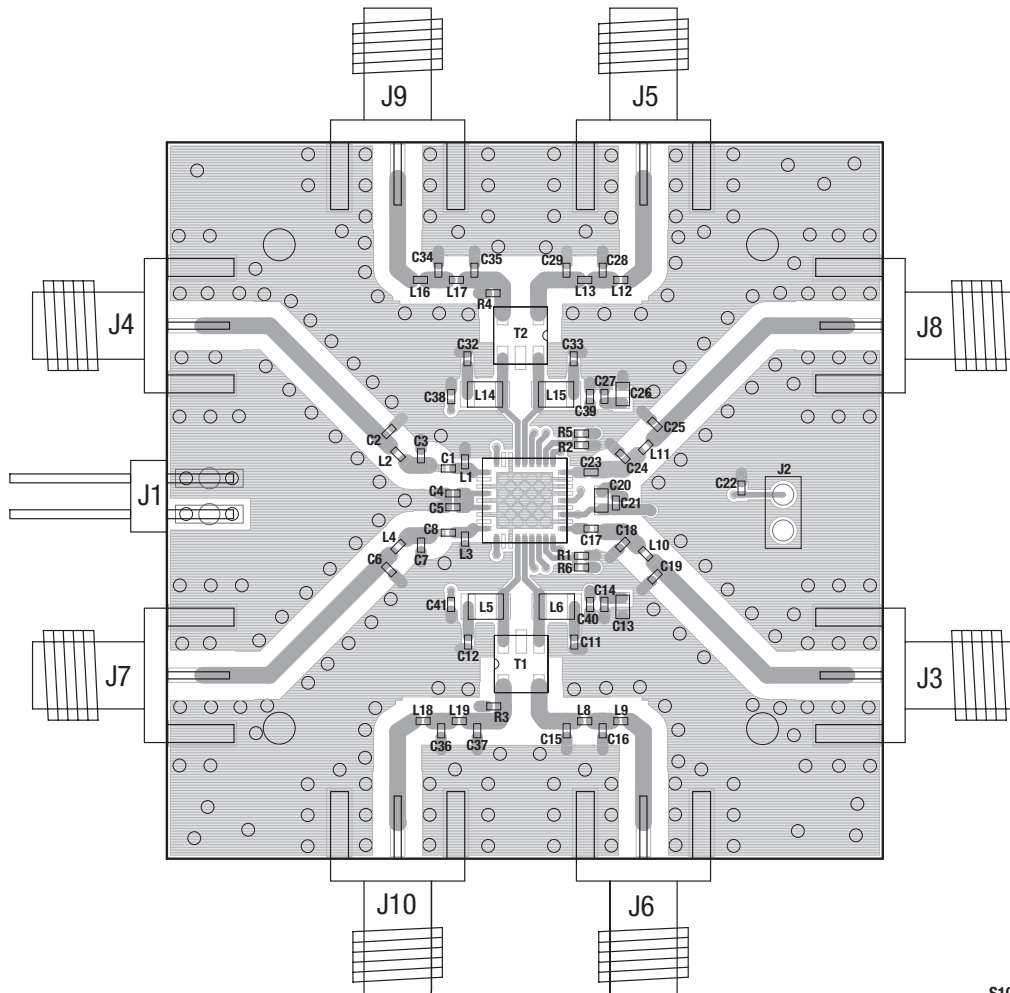
Evaluation Board Description

The SKY73025 Evaluation Board is used to test the performance of the SKY73025 downconversion mixer. An assembly drawing for the Evaluation Board is shown in Figure 4 and the layer detail is provided in Figure 5. A schematic diagram for the SKY73025 Evaluation Board is shown in Figure 6.



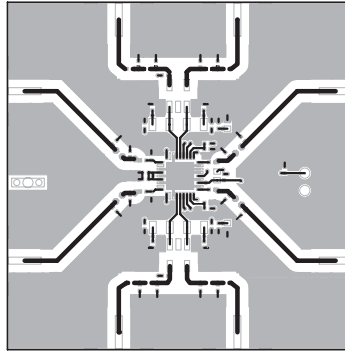
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Figure 3. Typical Single-Ended Application Circuit

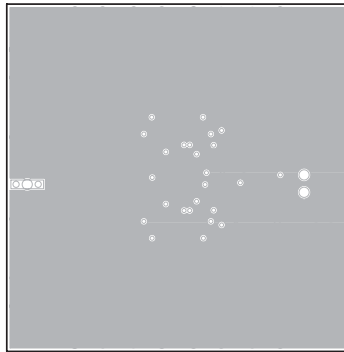


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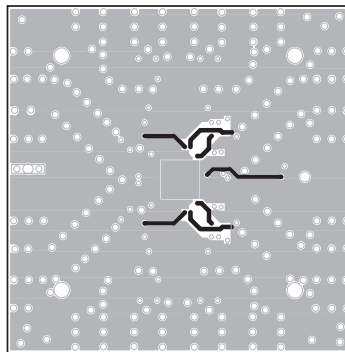
Figure 4. SKY73025 Evaluation Board Assembly Diagram



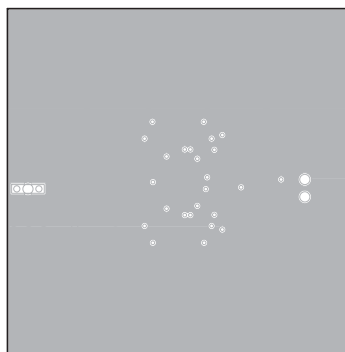
Layer 1: Top – Metal



Layer 2: Ground



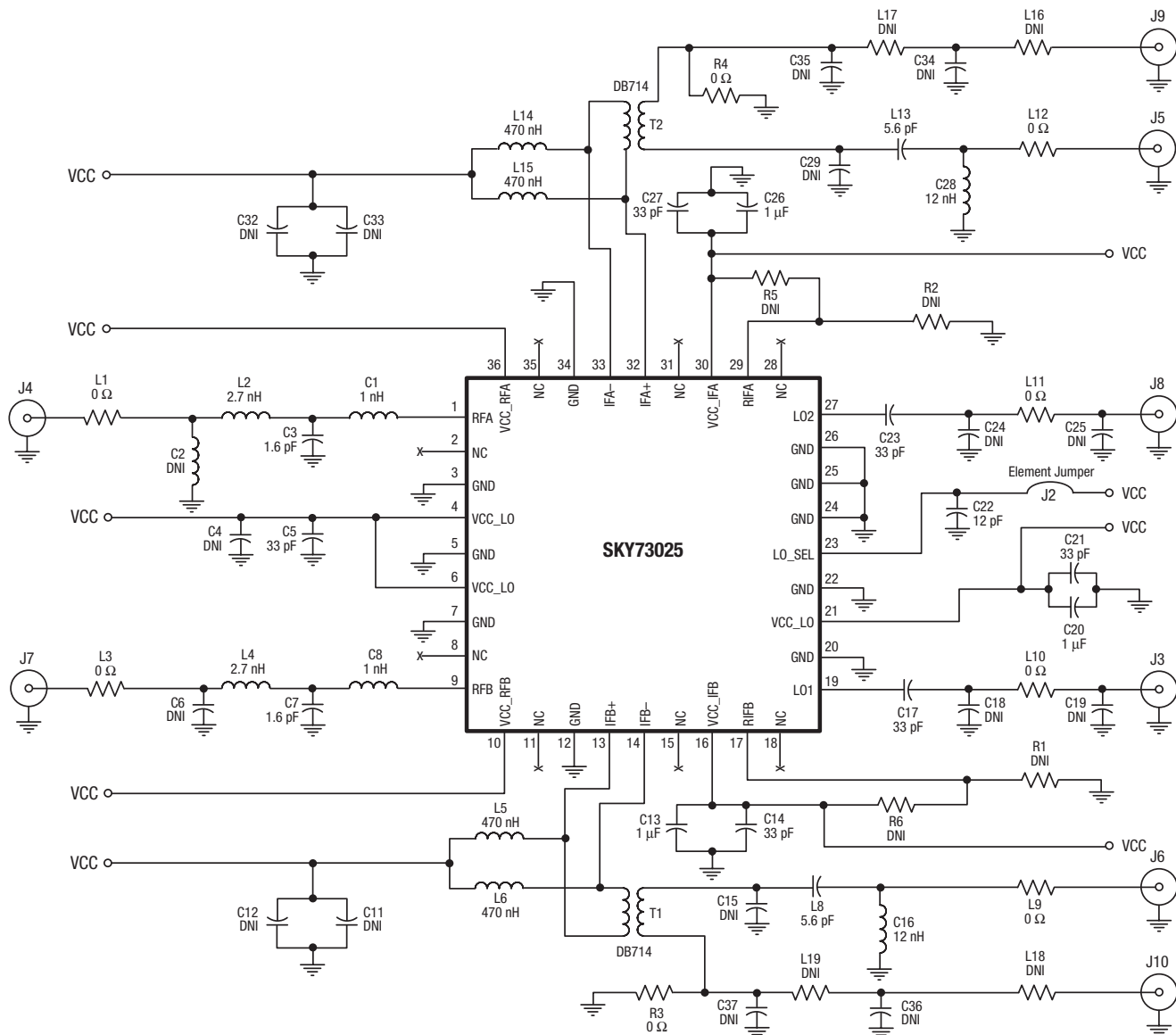
Layer 3: Power Plane



Layer 4: Solid Ground Plane

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Figure 5. SKY73025 Evaluation Board Layer Detail



Note: The Evaluation Board can be converted to provide a differential output by removing components T1, T2, R3, and R4.

Some component labels may be different than the corresponding component symbol shown here. Component values, however, are accurate as of the date of this Data Sheet.

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Figure 6. SKY73025 Evaluation Board Schematic

Package Dimensions

The PCB footprint for the SKY73025 is provided in Figure 7. Figure 8 shows the package dimensions for the 36-pin MCM, and Figure 9 provides the tape and reel dimensions.

Package and Handling Information

Since the device package is sensitive to moisture absorption, it is baked and vacuum packed before shipping. Instructions on the shipping container label regarding exposure to moisture after the container seal is broken must be followed. Otherwise, problems related to moisture absorption may occur when the part is subjected to high temperature during solder assembly.

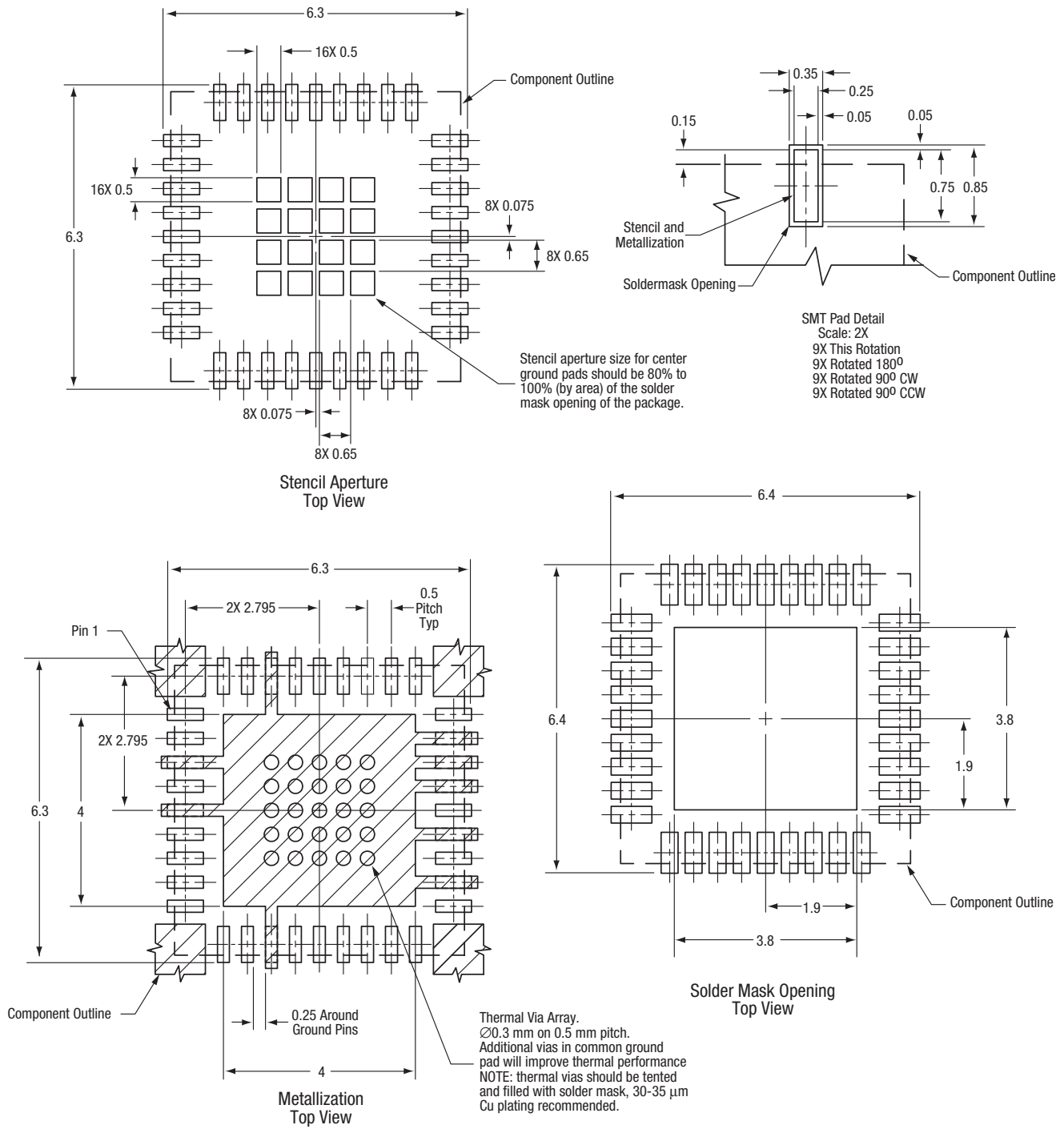
THE SKY73025 is rated to Moisture Sensitivity Level 3 (MSL3) at 260 °C. It can be used for lead or lead-free soldering. For additional information, refer to the Skyworks Application Note,

PCB Design & SMT Assembly/Rework Guidelines for MCM-L Packages, document number 101752.

Care must be taken when attaching this product, whether it is done manually or in a production solder reflow environment. Production quantities of this product are shipped in a standard tape and reel format. For packaging details, refer to the Skyworks Application Note, *Tape and Reel*, document number 101568.

Electrostatic Discharge (ESD) Sensitivity

The SKY73025 is a static-sensitive electronic device. Do not operate or store near strong electrostatic fields. Take proper ESD precautions.

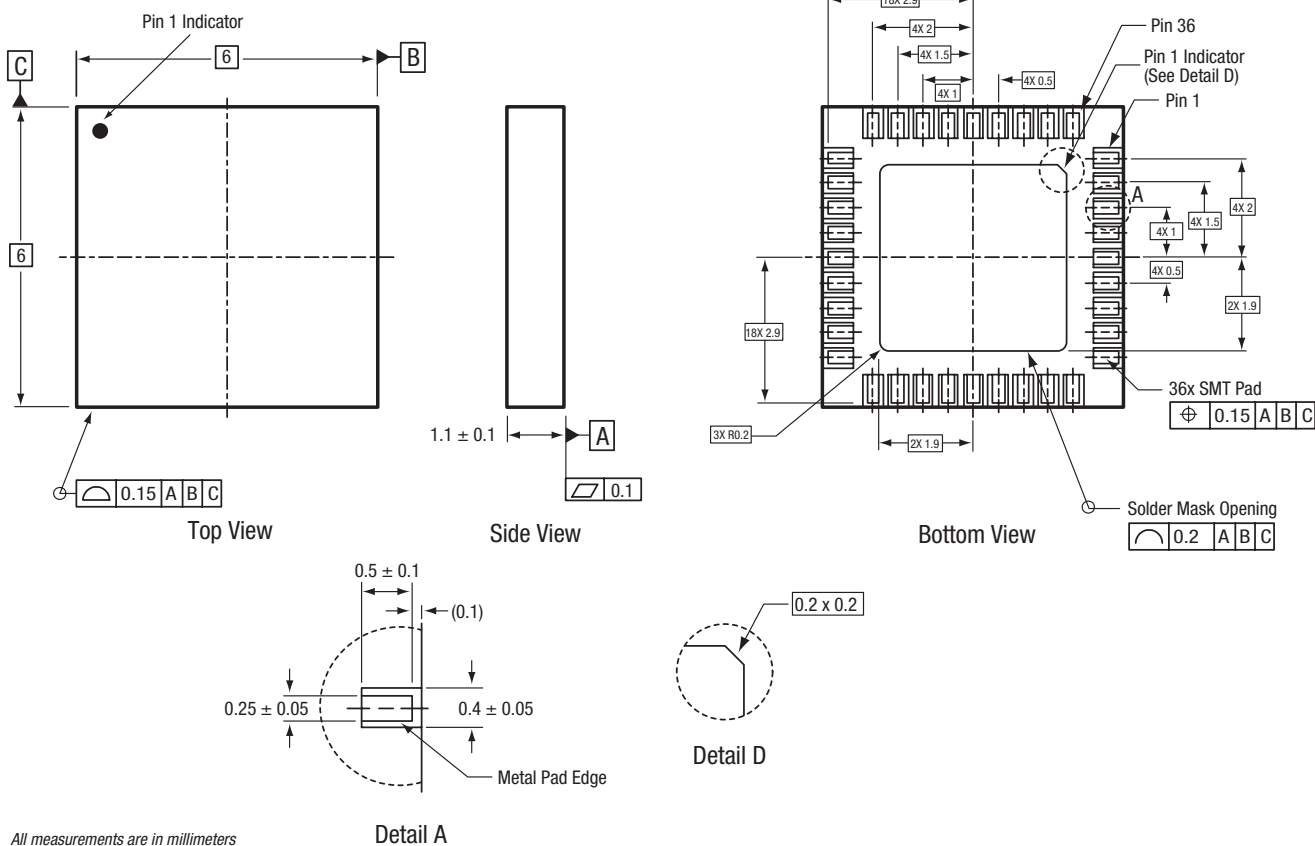


Note: The cross-hatched area represents the merger of the center ground pad + 9 individual I/O ground pads. All I/O ground pads should have at least one via connected to internal ground planes for optimum electrical performance.

All measurements are in millimeters

S1125

Figure 7. PCB Layout Footprint for the SKY73025 6 x 6 mm MCM



All measurements are in millimeters

Pads are solder mask defined on one edge and metal defined on three edges.

Dimensioning and tolerancing according to ASME Y14.5M-1994

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Figure 8. SKY73025 36-Pin MCM Package Dimensions

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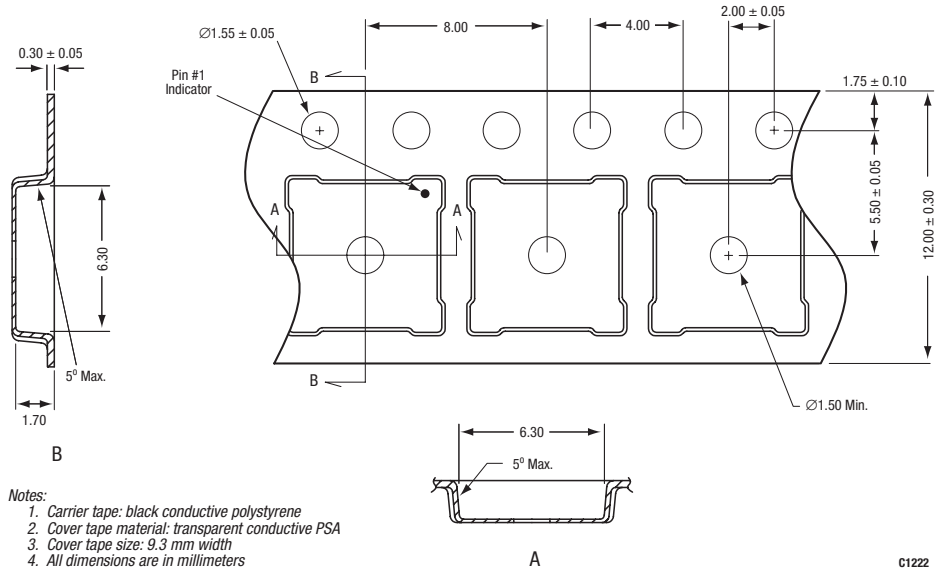


Figure 9. SKY73025 Tape and Reel Dimensions

Ordering Information

Model Name	Manufacturing Part Number	Evaluation Kit Part Number
SKY73025 Downconversion Mixer	SKY73025-11 (Pb-free package)	

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